506285244 10/01/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6331992

SUBMISSION TYPE:		N	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		A	ASSIGNMENT			
CONVEYING PARTY D	ΑΤΑ	•				
		Na	Name		Execution Date	
ROANIT FERNANDES					06/19/2020	
JEEVAN MADDUR SHANKAR SETTY					06/19/2020	
RECEIVING PARTY DA	ТА					
Name:	MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE					
Street Address:	DLF CYBER CITY, BLOCK NO. 3, GROUND FLOOR					
Internal Address:	PLOT NO. 129 TO 132, APHB COLONY					
City:	GACHIBOWLI, HYDERABAD					
State/Country:	INDIA					
Postal Code:	500019					
PROPERTY NUMBERS	Total: 1					
Property Type			Number			
Application Number: 16		1694434	6944341			
CORRESPONDENCE D Fax Number:	AIA	(203)492	0.5785			
	e sent to	. ,	nail address first; if that is i	unsuccessf	ul. it will be sent	
			is unsuccessful, it will be			
			4925000			
Email:			ents.two@medtronic.com, dspinillo@carterdeluca.com, t@carterdeluca.com			
Correspondent Name:	COVI		DIEN LP			
Address Line 1:	ddress Line 1: 60 M		IDDLETOWN AVENUE			
Address Line 2: MAIL		MAILST	STOP 54, LEGAL DEPT			
Audiess Line 2.						
Address Line 4:		NORTH	HAVEN, CONNECTICUT 06	473		
	JMBER:		HAVEN, CONNECTICUT 06	6473		

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DEED OF ASSIGNMENT

THIS DEED OF ASSIGNMENT IS EXECUTED BY

Roanit Fernandes, resident of Post H No12, 10-3-155/1, East Marredpally, Secunderabad, Hyderabad, INDIA 500026 (hereinafter 'Assignor') (which expression unless repugnant to the meaning or context thereof shall mean and include their respective heirs and executors) of the **ONE PART**

IN FAVOUR OF

Medtronic Engineering and Innovation Center Private Limited Address: DLF Cyber City, Block No. 3, Ground Floor, Plot No. 129 to 132, APHB Colony, Gachibowli, Hyderabad 500019 India (hereinafter 'Assignee') (which expression unless repugnant to the meaning or context thereof shall mean and include its successors and Assigns) and represented by its authorized signatory Mr./Ms. <u>Divya Prakash Joshi</u>, <u>Director</u> of the **OTHER PART**;

WHEREAS the Assignor is the inventor of an invention titled "<u>LINEAR STAPLING DEVICE WITH A GAP LOCKING</u> <u>MEMBER</u>", identified by reference number: <u>A0000387US01</u>, the subject of United States Provisional Patent Application Serial No. <u>62/913,961</u> filed <u>October 11, 2019</u>, hereinafter referred to as the "Invention".

Assignors hereby grant Assignee and Assignee's attorneys the power to insert the Serial No. and/or filing date of the above-described application(s) after such information becomes known to them.

WHEREAS Assignor is an employee of Assignee and recognizes that the Invention has been developed using the resources and facilities provided by Assignee in the course of the employment of Assignor, governed by the agreement of employment between Assignee and Assignor.

NOW THEREFORE, it is agreed that in consideration of the remuneration, facilities and perks received by Assignee, Assignor does hereby assign and transfer to Assignee the entire interest in the Invention disclosed in the invention disclosure with the above title and reference number, including all patent applications, utility model applications, design applications or other intellectual property rights, originating from the Invention, filed in any country including all divisional and continuation applications and the right to claim priority from such applications including the right to claim priority under the Paris Convention for the Protection of Industrial Property, all re-examination applications, all re-issue applications, and any patents, utility models, designs or other intellectual property rights which may issue for the Invention.

Assignor further agrees and warrants to execute all such further papers and perform such other acts as Assignee may reasonably request to obtain or maintain such patents, utility models, designs other intellectual property rights in any country.

It is understood and agreed to by the parties hereto, that on the execution of this Deed of Assignment, no rights of any nature whatsoever, in respect of such Intellectual Property, shall survive with Assignor. Assignor further undertakes not to

PATENT REEL: 053954 FRAME: 0605

make any claim in the future with regard to such Intellectual Property assigned to the Assignee vide this Deed of Assignment.

Authorized signatory of Assignor

FOANIT.P

Signature

Name: Roanit Fernandes

Place, Date: Secunderabad, 19-JUN-2020

Assignee hereby acknowledges and agrees to such assignment and transfer

Authorized signatory of Assignee

	· phi-
Signature	T L
Name:	Divya Prakash Joshi
Place, Date:	Hyderabad, 7 - July - 2020

DEED OF ASSIGNMENT

THIS DEED OF ASSIGNMENT IS EXECUTED BY

Jeevan Maddur Shankar Setty, resident of Post Flat # 15/2, 5th C-cross, 7th Main, 3rd Block, Nandini Layout, Bangalore, 560096, INDIA (hereinafter 'Assignor') (which expression unless repugnant to the meaning or context thereof shall mean and include their respective heirs and executors) of the ONE PART

IN FAVOUR OF

Medtronic Engineering and Innovation Center Private Limited

Address: DLF Cyber City, Block No. 3, Ground Floor, Plot No. 129 to 132, APHB Colony, Gachibowli, Hyderabad 500019 India (hereinafter 'Assignee') (which expression unless repugnant to the meaning or context thereof shall mean and include its successors and Assigns) and represented by its authorized signatory Mr./Ms. <u>Divya Prakash Joshi</u>, <u>Director</u> of the **OTHER PART**;

WHEREAS the Assignor is the inventor of an invention titled "LINEAR STAPLING DEVICE WITH A GAP LOCKING <u>MEMBER</u>", identified by reference number: <u>A0000387US01</u>, the subject of United States Provisional Patent Application Serial No. <u>62/913.961</u> filed <u>October 11, 2019</u>, hereinafter referred to as the "Invention".

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Assignor further agrees and warrants to execute all such further papers and perform such other acts as Assignee may reasonably request to obtain or maintain such patents, utility models, designs other intellectual property rights in any country.

It is understood and agreed to by the parties hereto, that on the execution of this Deed of Assignment, no rights of any nature whatsoever, in respect of such Intellectual Property, shall survive with Assignor. Assignor further undertakes not to

PATENT REEL: 053954 FRAME: 0607

make any claim in the future with regard to such Intellectual Property assigned to the Assignee vide this Deed of Assignment.

Authorized signatory of Assignor

6 QNO

Signature

Name:

Jeevan Maddur Shankar Setty

Place, Date:

Bongalde 19-JUN-2020

Assignce hereby acknowledges and agrees to such assignment and transfer

Authorized signatory of Assignee

Signature Name: Divya Prakash Joshi

Place, Date: Hyderabad, 7 - July - 2020

PATENT REEL: 053954 FRAME: 0608

RECORDED: 10/01/2020